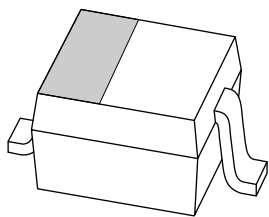


DATA SHEET



BB156

Low-voltage variable capacitance
diode

Product specification
Supersedes data of 1998 Aug 17

2004 Mar 01

Low-voltage variable capacitance diode

BB156

FEATURES

- Excellent linearity
- Very small plastic SMD package
- C7.5: 4.8 pF; ratio 3.3
- Very low series resistance.

APPLICATIONS

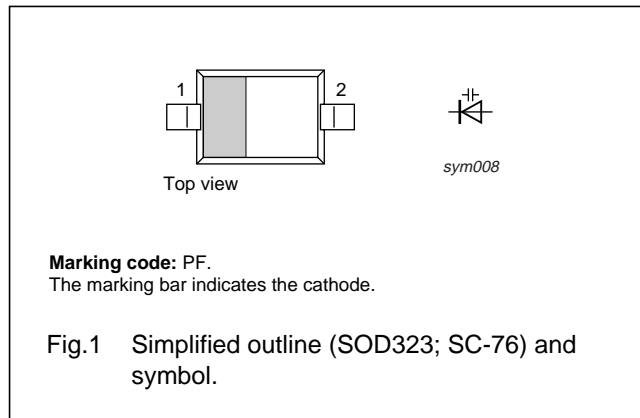
- Voltage controlled oscillators (VCO).

DESCRIPTION

The BB156 is a planar technology variable capacitance diode, in a SOD323 very small plastic SMD package.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | cathode |
| 2 | anode |



ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | |
|-------------|---------|--|---------|
| | NAME | DESCRIPTION | VERSION |
| BB156 | – | plastic surface mounted package; 2 leads | SOD323 |

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL | PARAMETER | MIN. | MAX. | UNIT |
|-----------|--------------------------------|------|------|------|
| V_R | continuous reverse voltage | – | 10 | V |
| I_F | continuous forward current | – | 20 | mA |
| T_{stg} | storage temperature | –55 | +150 | °C |
| T_j | operating junction temperature | –55 | +125 | °C |

Low-voltage variable capacitance diode

BB156

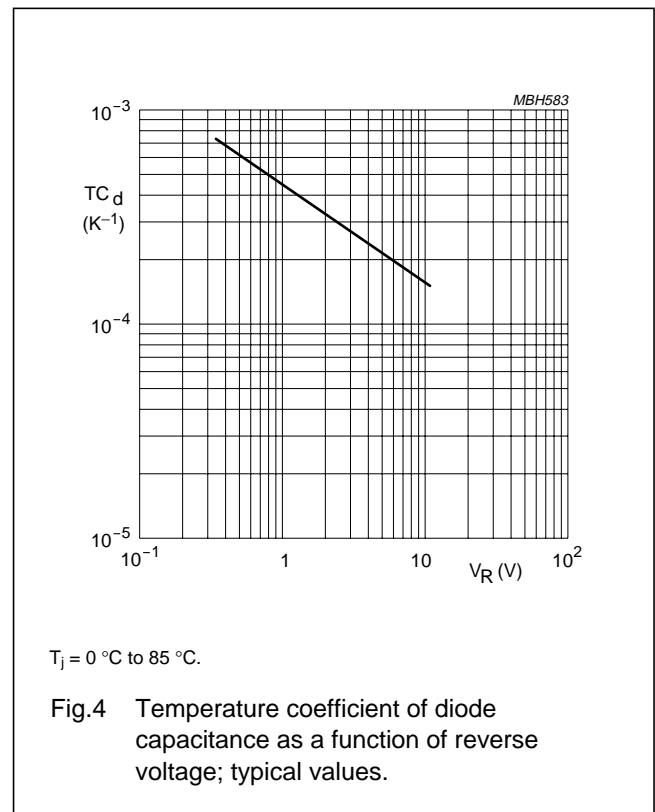
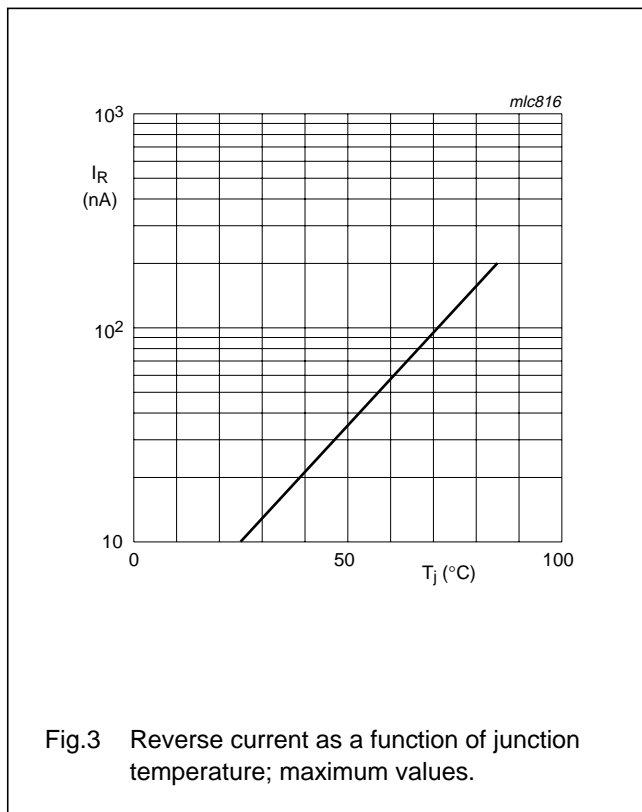
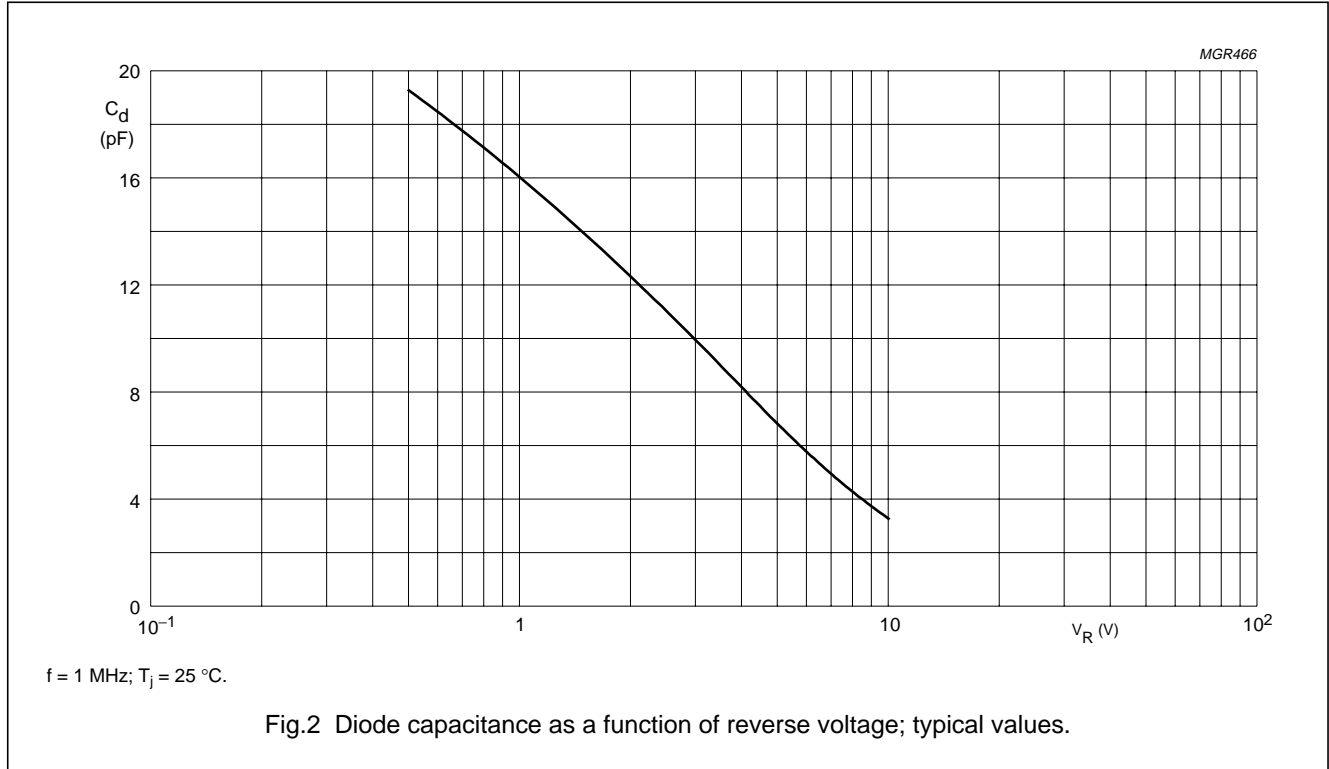
ELECTRICAL CHARACTERISTICS $T_j = 25\text{ °C}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|-------------------------|--|------|------|------|----------|
| I_R | reverse current | $V_R = 10\text{ V}$; see Fig.3 | – | – | 10 | nA |
| | | $V_R = 10\text{ V}$; $T_j = 85\text{ °C}$; see Fig.3 | – | – | 200 | nA |
| r_s | diode series resistance | $f = 470\text{ MHz}$; $C_d = 9\text{ pF}$ | – | 0.4 | 0.7 | Ω |
| C_d | diode capacitance | $f = 1\text{ MHz}$; see Figs 2 and 4 | | | | |
| | | $V_R = 1\text{ V}$ | 14.4 | 16 | 17.6 | pF |
| | | $V_R = 4\text{ V}$ | 7.6 | 8.6 | 9.6 | pF |
| | | $V_R = 7.5\text{ V}$ | 4.2 | 4.8 | 5.4 | pF |
| $\frac{C_{d(1\text{ V})}}{C_{d(7.5\text{ V})}}$ | capacitance ratio | $f = 1\text{ MHz}$ | 2.7 | 3.3 | 3.9 | |

Low-voltage variable capacitance diode

BB156

GRAPHICAL DATA



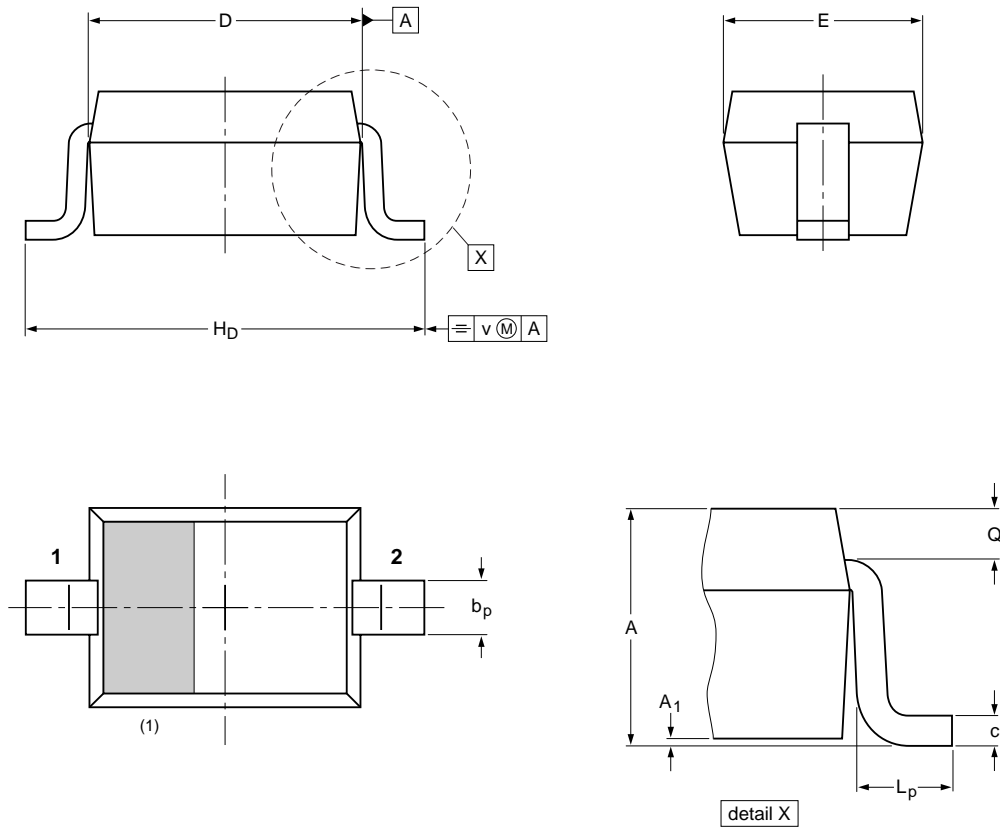
Low-voltage variable capacitance diode

BB156

PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD323



DIMENSIONS (mm are the original dimensions)

| UNIT | A | A ₁ max | b _p | c | D | E | H _D | L _p | Q | v |
|------|------------|-----------------------|----------------|--------------|------------|--------------|----------------|----------------|--------------|-----|
| mm | 1.1 0.8 | 0.05 | 0.40 0.25 | 0.25 0.10 | 1.8 1.6 | 1.35 1.15 | 2.7 2.3 | 0.45 0.15 | 0.25 0.15 | 0.2 |

Note

1. The marking bar indicates the cathode

| OUTLINE VERSION | REFERENCES | | | EUROPEAN PROJECTION | ISSUE DATE |
|--------------------|------------|-------|-------|------------------------|------------------------|
| | IEC | JEDEC | JEITA | | |
| SOD323 | | | SC-76 | | -99-09-13- 03-12-17 |

Low-voltage variable capacitance diode

BB156

DATA SHEET STATUS

| LEVEL | DATA SHEET STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾⁽³⁾ | DEFINITION |
|-------|----------------------------------|----------------------------------|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
| II | Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product. |
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3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Printed in The Netherlands

R77/02/pp7

Date of release: 2004 Mar 01

Document order number: 9397 750 12658

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